



## 2SB1202/2SD1802

Continued from preceding page.

Parameter	Symbol	Conditions	Ratings	Unit
Collector Dissipation	PC		1	W
		$T_c=25^\circ\text{C}$	15	W
Junction Temperature	$T_j$		150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$		-55 to +150	$^\circ\text{C}$

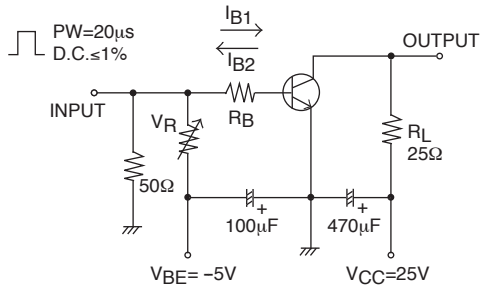
### Electrical Characteristics at $T_a=25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	$I_{CBO}$	$V_{CB}=(-)40\text{V}, I_E=0\text{A}$			(-1)	$\mu\text{A}$
Emitter Cutoff Current	$I_{EBO}$	$V_{EB}=(-)4\text{V}, I_C=0\text{A}$			(-1)	$\mu\text{A}$
DC Current Gain	$h_{FE1}$	$V_{CE}=(-)2\text{V}, I_C=(-)100\text{mA}$	100*		560*	
	$h_{FE2}$	$V_{CE}=(-)2\text{V}, I_C=(-)3\text{A}$	35			
Gain-Bandwidth Product	$f_T$	$V_{CE}=(-)10\text{V}, I_C=(-)50\text{mA}$		150		MHz
Output Capacitance	$C_{ob}$	$V_{CB}=(-)10\text{V}, f=1\text{MHz}$		(39)25		pF
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=(-)2\text{A}, I_B=(-)100\text{mA}$		(-0.35)0.19	(-0.7)0.5	mV
Base-to-Emitter Saturation Voltage	$V_{BE(sat)}$	$V_{CE}=(-)2\text{V}, I_C=(-)100\text{mA}$		(-0.94)	(-1.2)	V
Collector-to-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C=(-)10\mu\text{A}, I_E=0\text{A}$	(-60)			V
Collector-to-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C=(-)1\text{mA}, R_{BE}=\infty$	(-50)			V
Emitter-to-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E=(-)10\mu\text{A}, I_C=0\text{A}$	(-6)			V
Turn-On Time	$t_{on}$	See specified Test Circuit.		70		ns
Storage Time	$t_{stg}$			(450)650		ns
Fall Time	$t_f$			35		ns

\* : The 2SB1202/2SD1802 are classified by 100mA hFE as follows :

Rank	R	S	T	U
hFE	100 to 200	140 to 280	200 to 400	280 to 560

### Switching Time Test Circuit



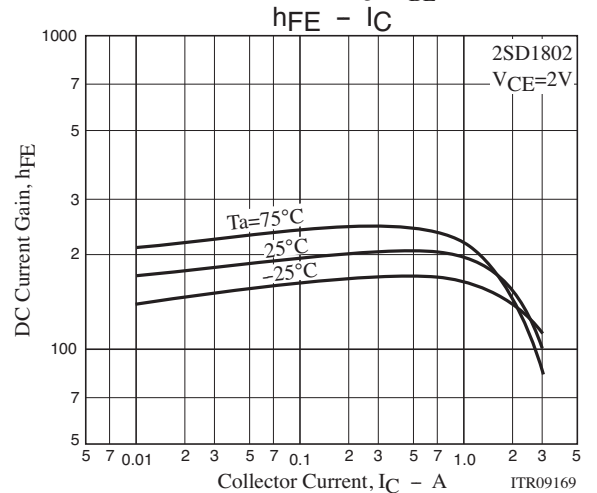
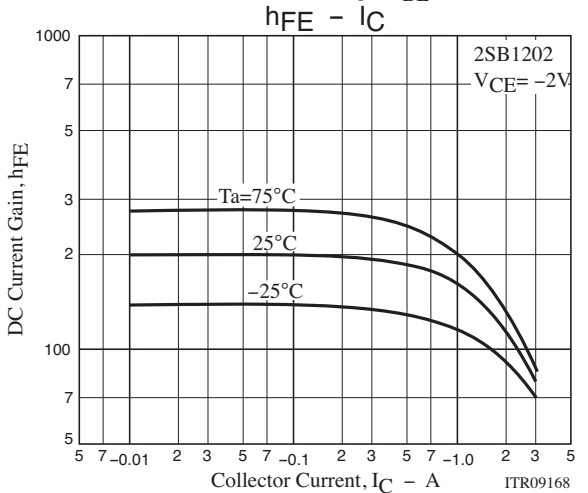
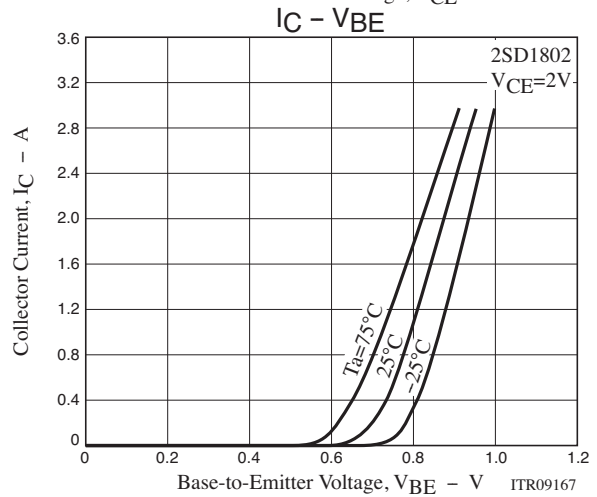
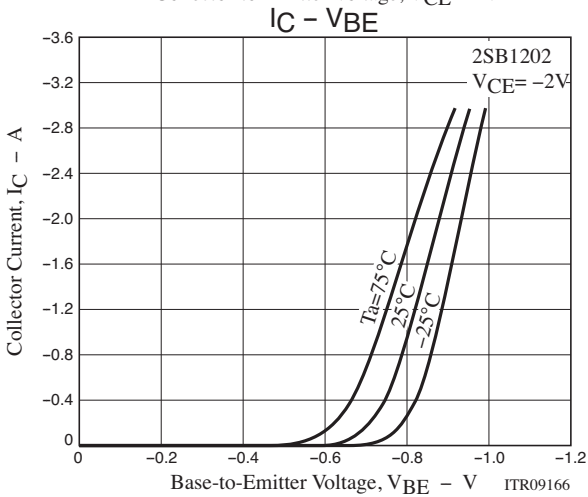
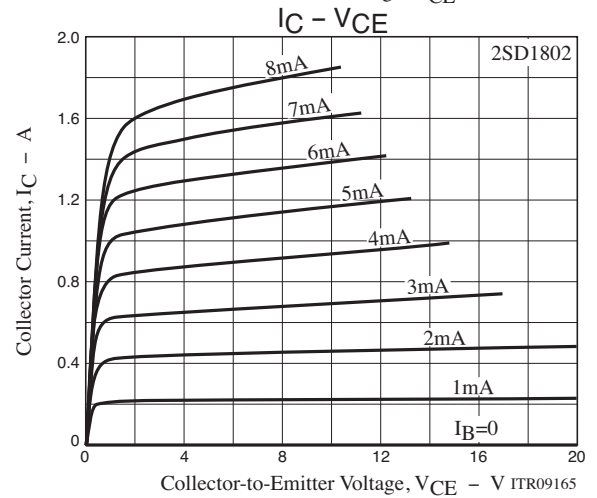
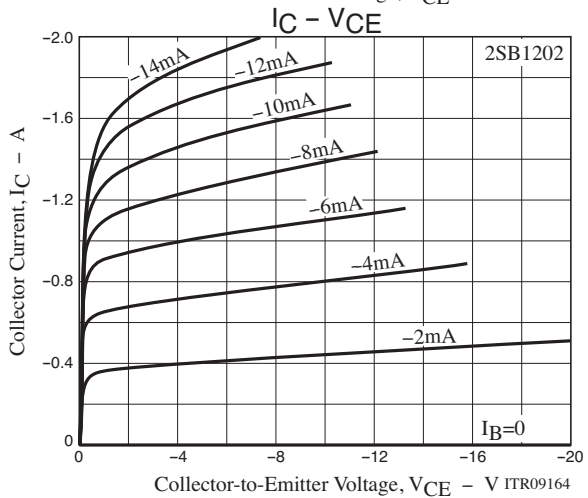
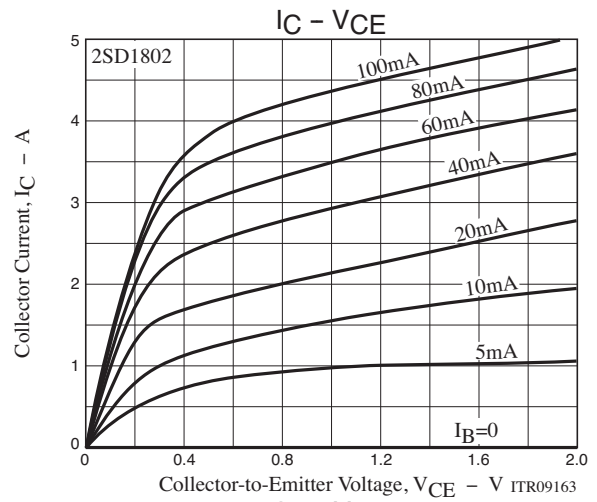
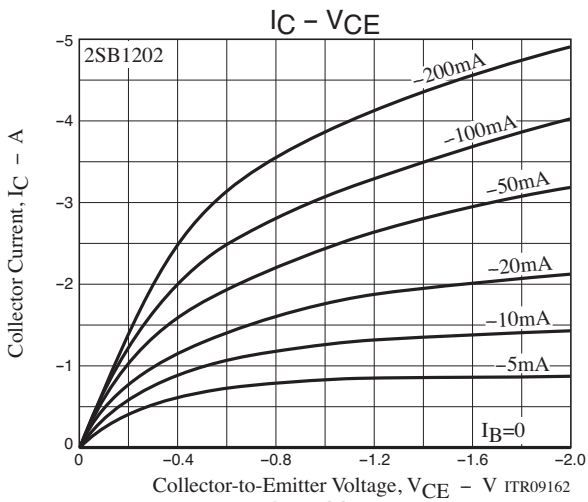
$$I_C=10I_{B1}=-10I_{B2}=1\text{A}$$

For PNP, the polarity is reversed.

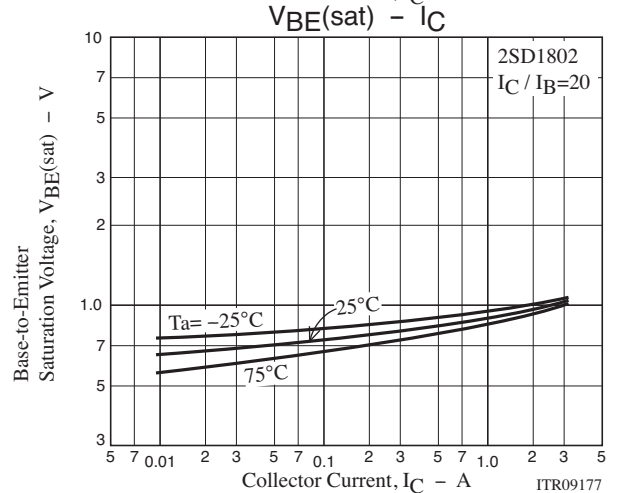
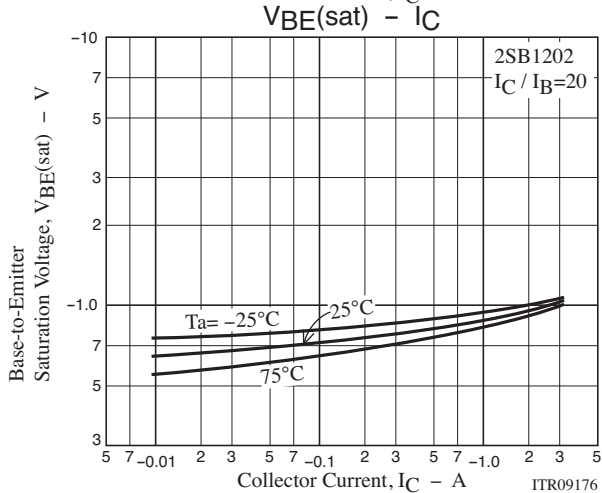
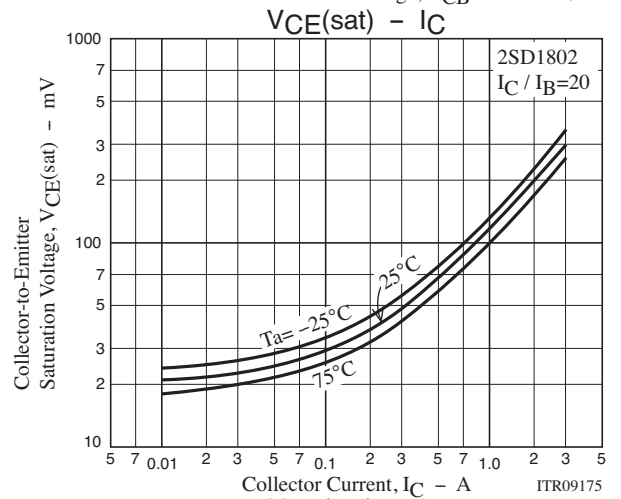
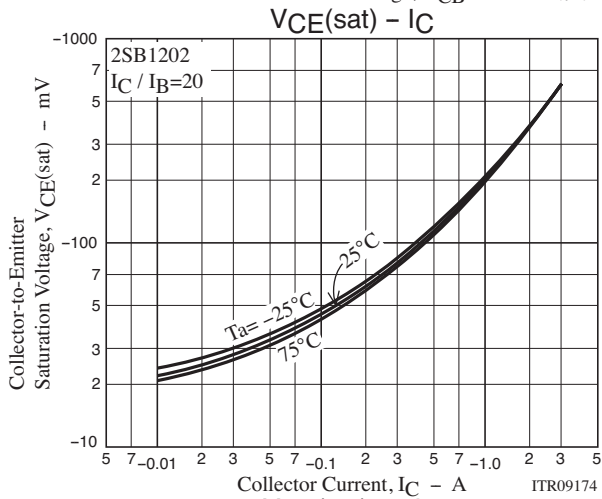
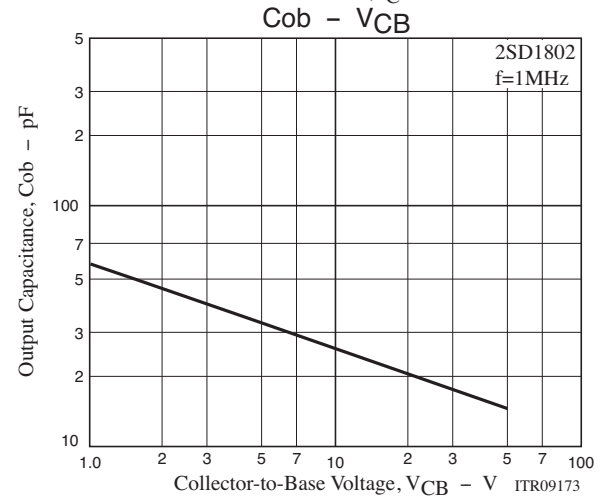
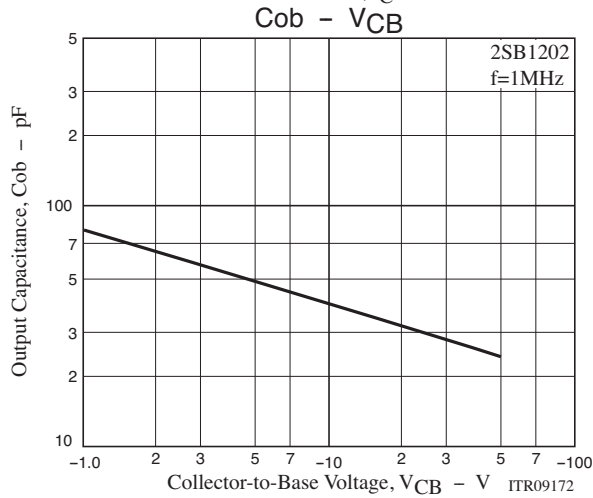
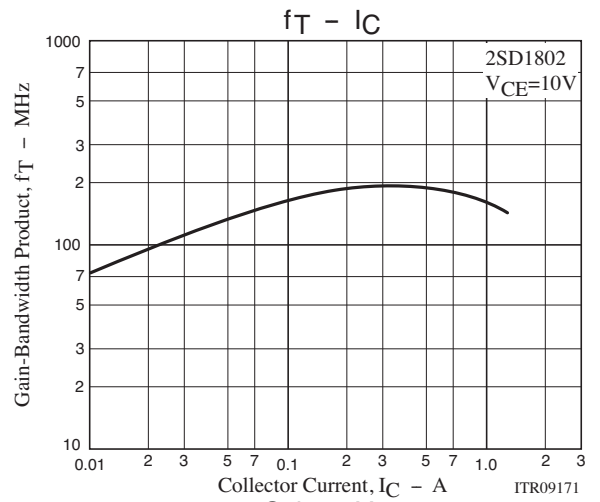
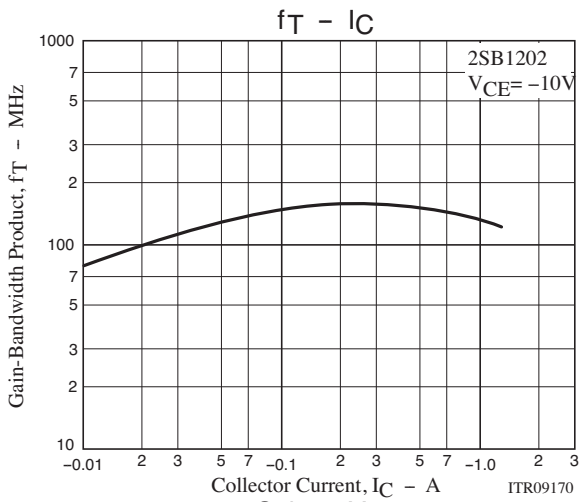
### Ordering Information

Device	Package	Shipping	memo
2SB1202S-E	TP	500pcs./bag	Pb Free
2SB1202T-E	TP	500pcs./bag	
2SD1802S-E	TP	500pcs./bag	
2SD1802T-E	TP	500pcs./bag	
2SB1202S-TL-E	TP-FA	700pcs./reel	
2SB1202T-TL-E	TP-FA	700pcs./reel	
2SD1802S-TL-E	TP-FA	700pcs./reel	
2SD1802T-TL-E	TP-FA	700pcs./reel	

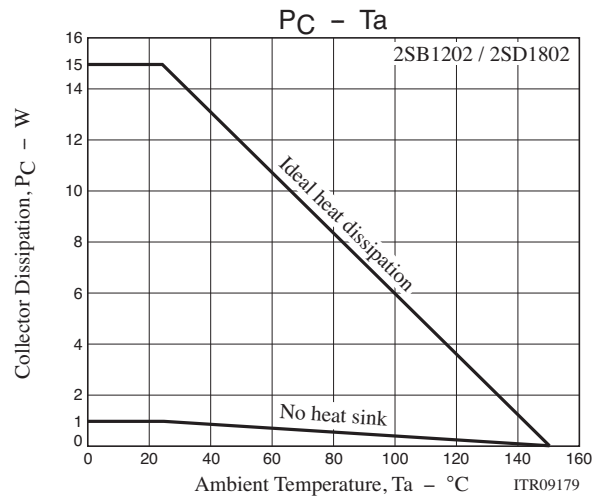
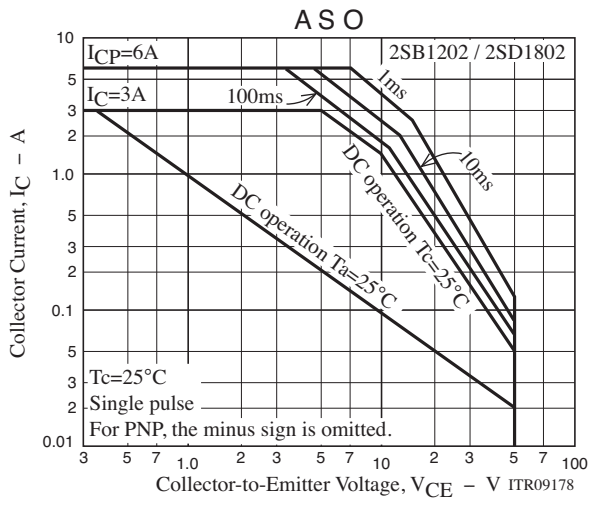
2SB1202/2SD1802



# 2SB1202/2SD1802



## 2SB1202/2SD1802



# 2SB1202/2SD1802

## Taping Specification

2SB1202S-TL-E, 2SB1202T-TL-E, 2SD1802S-TL-E, 2SD1802T-TL-E

### Packing Format

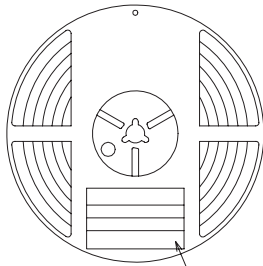
Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
TP-FA	TP	700	2,100	12,600	3 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Reel label, Inner box label  
(unit:mm)

Outer box label

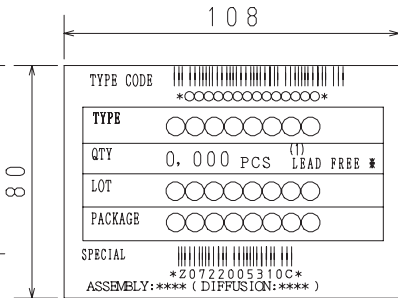
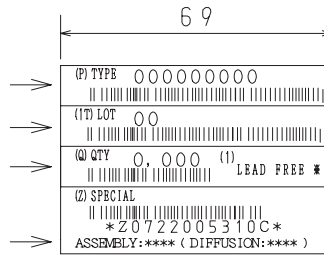
It is a label at the time of factory shipments.  
The form of a label may change in physical distribution process.

### Packing method



Reel label

Type No.  
LOT No.  
Quantity  
Origin



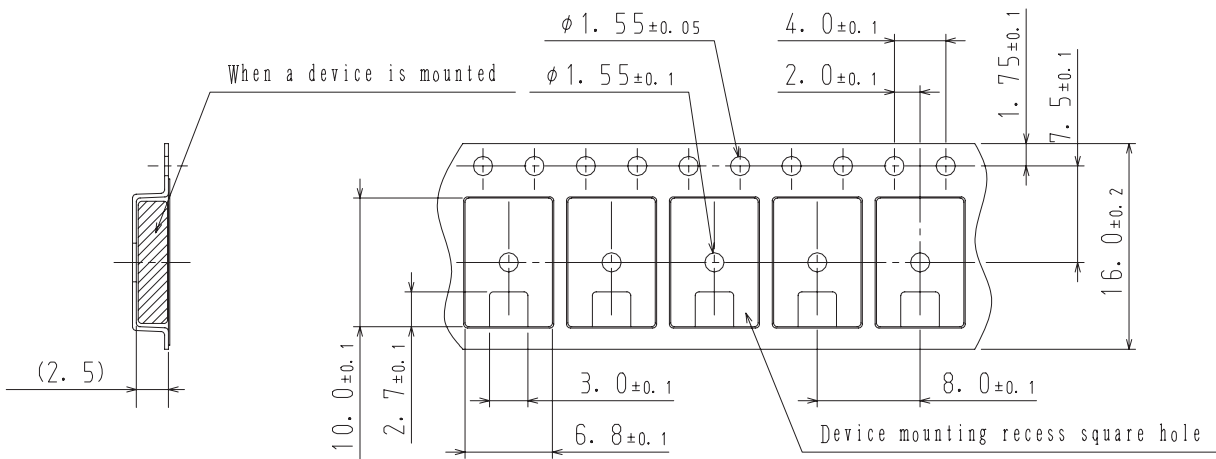
#### NOTE (1)

The LEAD FREE \* description shows that the surface treatment of the terminal is lead free.

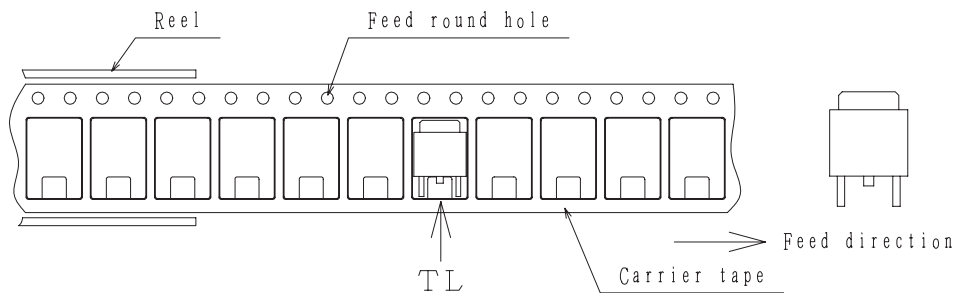
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

### Taping configuration

#### 1. Carrier tape size (unit:mm)



#### 2. Device placement direction



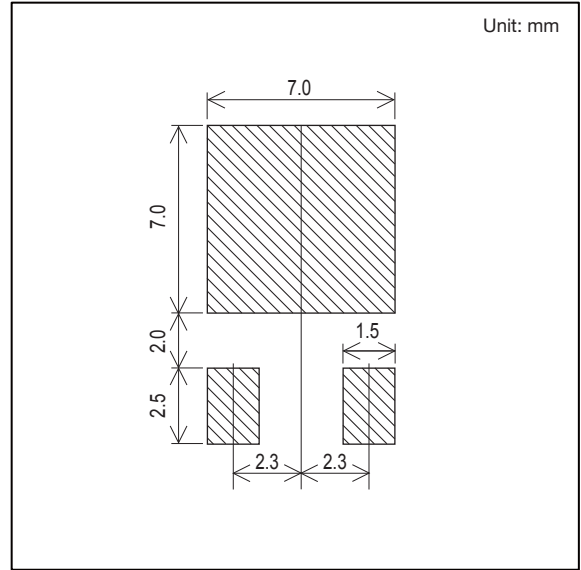
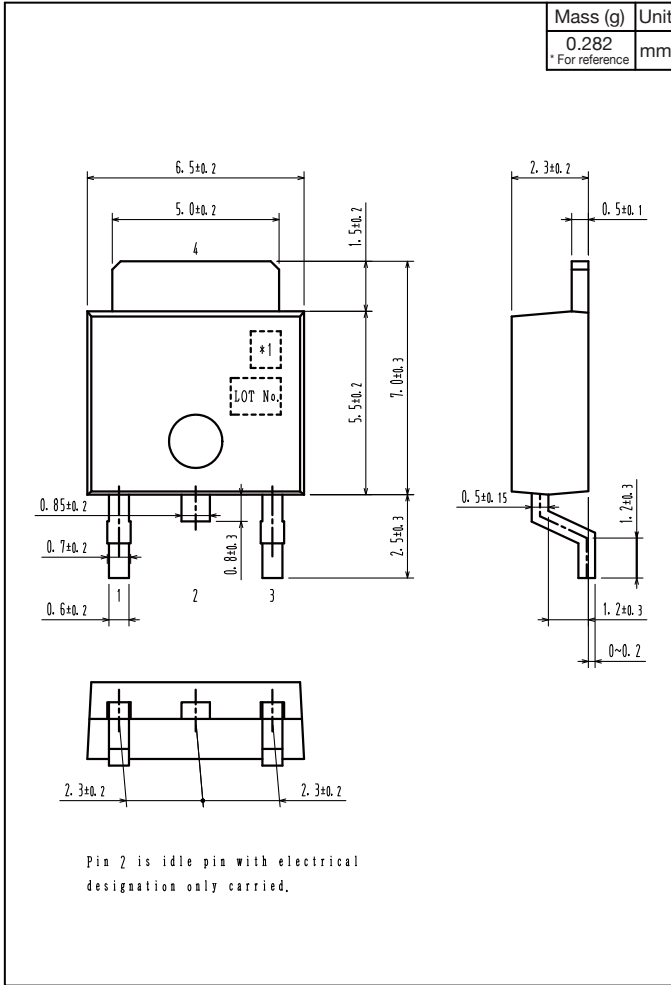
Those with one electrode terminal on the feed hole side.....TL

# 2SB1202/2SD1802

## Outline Drawing

## Land Pattern Example

2SB1202S-TL-E, 2SB1202T-TL-E, 2SD1802S-TL-E, 2SD1802T-TL-E



# 2SB1202/2SD1802

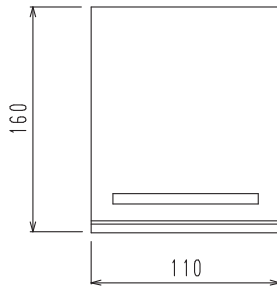
## Bag Packing Specification

2SB1202S-E, 2SB1202T-E, 2SD1802S-E, 2SD1802T-E

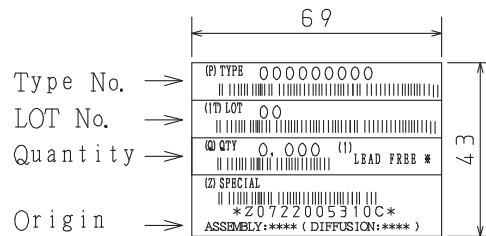
### 1. Packing Format

Package Name	Maximum Number of devices contained (pcs)			
	Bag	Inner box	Outer box	
TP	500	B-1	A-1	A-2
		10,000	50,000	30,000
	Packing format (Dimensions:mm (external))			
		Inner box	Outer box	
		B-1	A-1	A-2
		445×225×55	470×250×300	470×250×190

### 2. Bag dimensions (unit:mm)



### 3. Bag label, Inner box label (unit:mm)



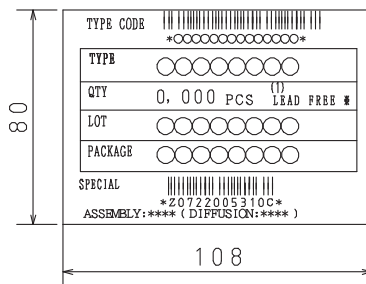
### 4. Outer box label (unit:mm)

It is a label at the time of factory shipments.  
The form of a label may change in physical  
distribution process.

#### NOTE (1)

The LEAD FREE \* description shows that the  
surface treatment of the terminal is lead free.

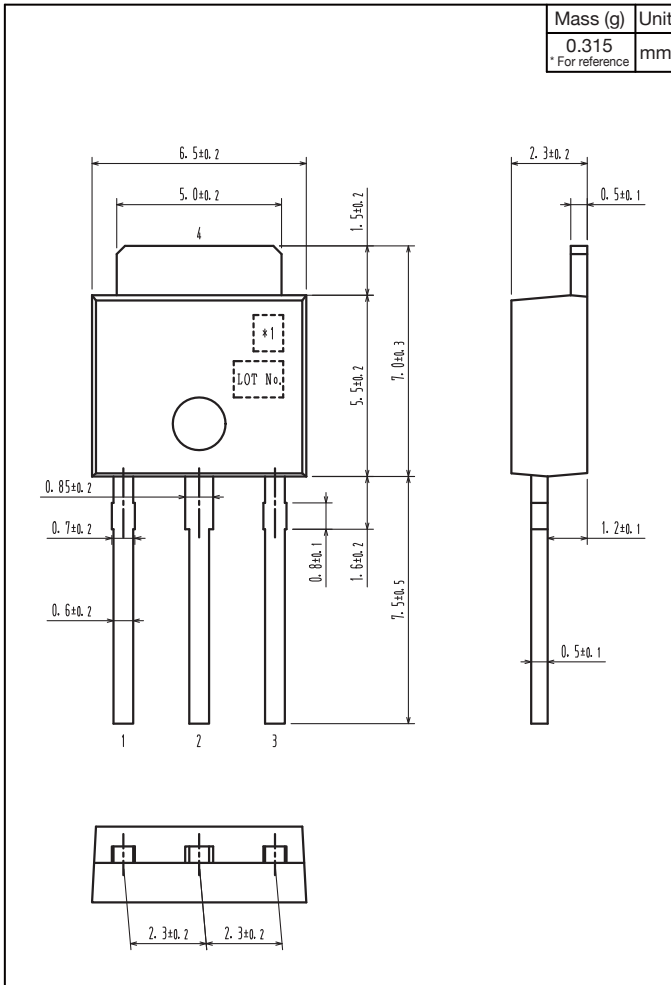
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3



# 2SB1202/2SD1802

## Outline Drawing

2SB1202S-E, 2SB1202T-E, 2SD1802S-E, 2SD1802T-E



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